

<Drawing when a tray is inserted>

Note: Tray is not included. Tray is to be prepared by customers.

<<Outline>>

Recently, smartphones and tablet PC have been equipped with nanoSIM cards. The SF70 Series is a push-eject tray type (ejected by pushing pin) connector compatible with the nanoSIM card.

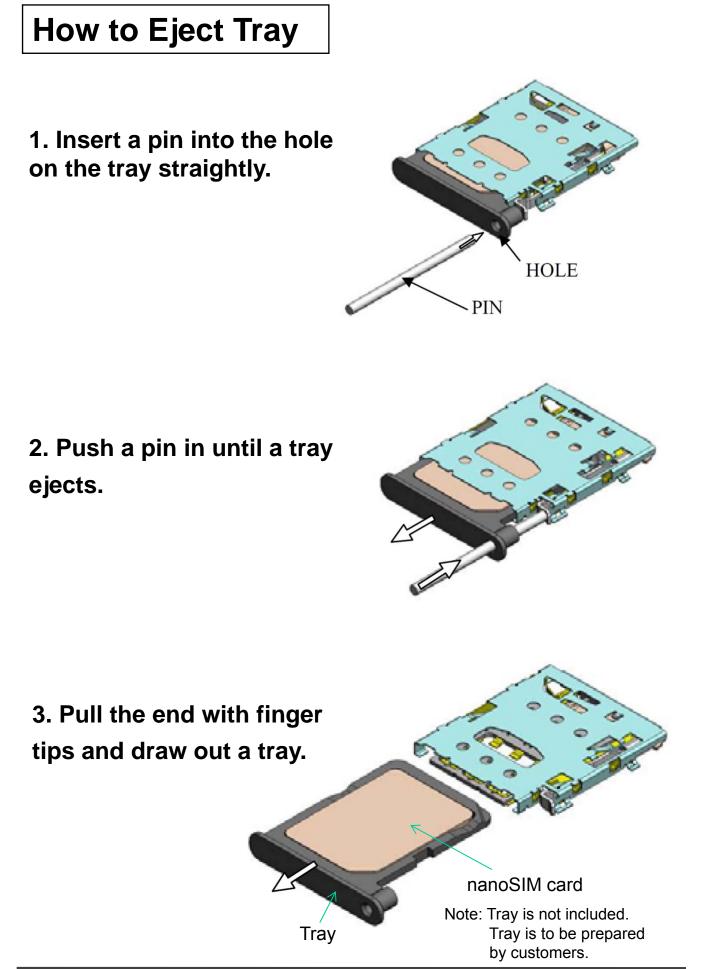
(SIM: <u>Subscriber</u> <u>I</u>dentity <u>M</u>odule)

Features

- ■1.25mm height, 13.3mm width, and 14.8mm depth, low-profile, space-saving.
- Superior resistance against drop with original lock structure.
- Card mis-insertion measures, card detection with SW (normal open).
- Structure that enables visual check / repair of terminal area after SMT mounting.
- ■Balanced 7 hold-down points for good EMI performance.
- ■Pb-free, halogen-free compliant product.
- Supports automated mounting with embossed tape.

General Specifications

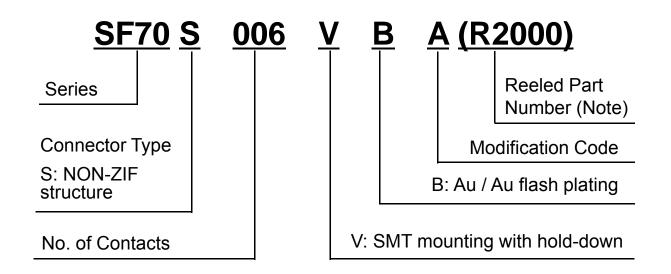
- ■No. of Contacts: 6 pos.
- Contact Resistance: 100mΩ max. (initial)
- Dielectric Withstanding Voltage:
 - AC500Vr.m.s for 1 minute
- Operating Temperature : -25 Deg. C to +85 Deg. C
- ■Rated Current: 0.5A per terminal
- ■Rated Voltage: 10V per terminal
- ■Durability: 5,000 times



Materials and Finishes

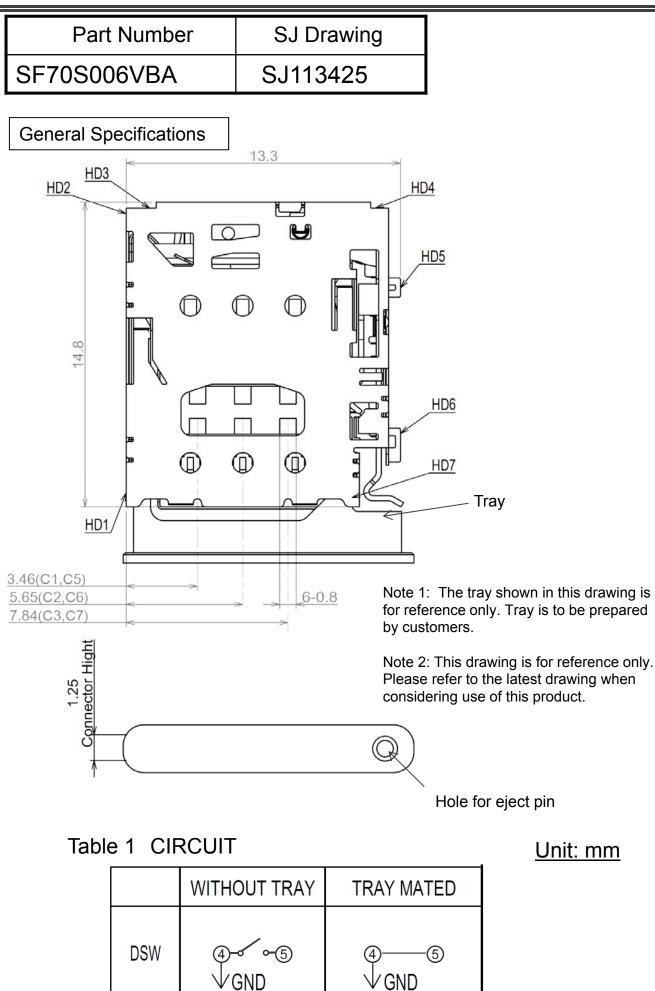
Component	Material and Finish
Signal Contact D-SW Contact	Copper alloy / Contact area Au plating over Ni Termination area Au flash plating over Ni
Housing	Synthetic resin / None
Cover Frame	Stainless steel / Terminal area: Au flash plating over Ni
Eject Bar	Stainless steel / None
Eject Lever	Stainless steel / None

Ordering Information



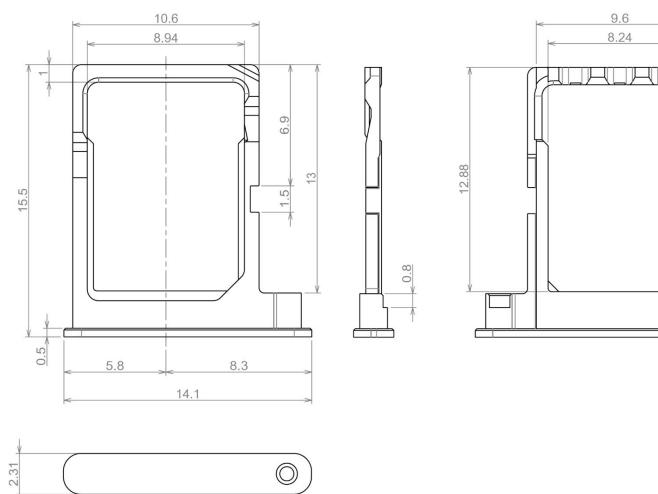
Note: An embossed tape reel contains 2,000 pieces.

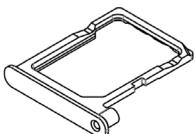
Please contact us concerning packaging specifications.



Recommended Tray



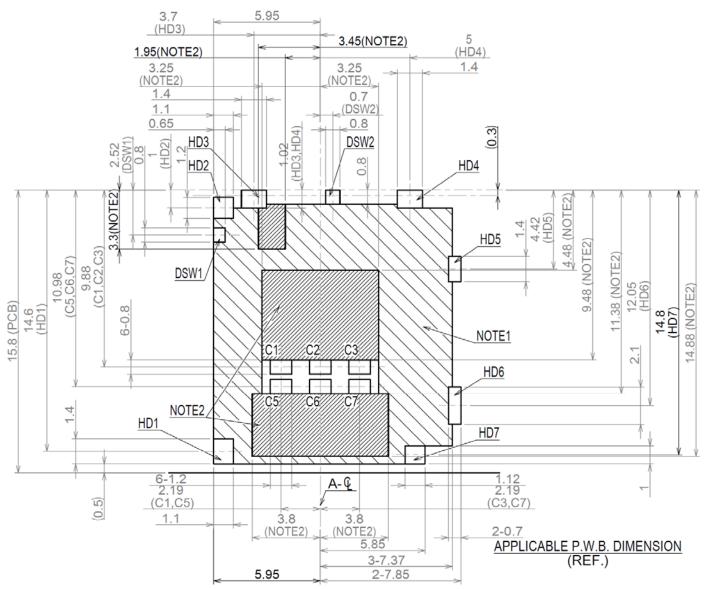




Unit: mm

Note 1: Above are recommended dimensions for tray designed by customers. Note 2: Above drawing is for reference only. Please refer to the most updated product drawing when considering use of this product.

Recommended Board Patterns



NOTE 1: ONLY GND PATTERN AND VIA HOLE IN ALLOWED IN THIS AREA. NOTE 2: NO PATTERN , NO VIA HOLE IN THIS AREA.

Note 3: Above drawing is for reference only. Please refer to the most updated product drawing when considering use of this product.

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* The specifications in this brochure are subject to change without notice. Please contact JAE for information.

<u>Notice</u>: Products shown in this brochure are made for the applications listed below. However, if the above-mentioned products are to be used in aerospace devices, marine cable-connection devices, atomic power control systems, medical equipment for lifesupport systems, or any other specific application requiring extremely high reliability, please contact

Recommended applications: Computers, Office

Household applications, FA devices, etc.

machines, Measuring devices, Telecommunication

devices (Terminals, Mobile devices), AV devices,

JAE for further information.

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